

# **Preliminary Datasheet**

## N+P-30V MOSFET

## **FEATURES**

- Advance Trench Process Technology
- ●High Density Cell Design for Ultra Low On-resistance

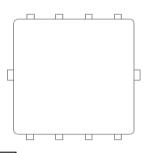
# **Application**

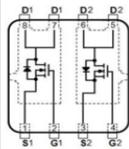
- Portable Devices
- ■Consumer Electronics

## **Mechanical**

●Case:DFN3333 Package

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## **Packing Information**

Package	Packing
DFN3333	5Kpcs/13"Reel

Maximum Ratings (T <sub>A</sub> =25°C unless otherwise specified)								
Parameter	Symbol	Lin	Limit					
Farameter	Syllibol	N-Channel	P-Channel	Unit				
Drain-Source Voltage	$V_{DS}$	30	-30	V				
Gate-Source Voltage	$V_{GS}$	±20	±20	V				
Continuous Drain Current 1)	I <sub>D</sub>	15	-13	Α				
Continuous Drain Current 4)	I <sub>DM</sub>	60	-52	А				
Maximum Power Dissipation	$P_{D}$	5	5	W				
Operating Junction and Storage Temperature Range	$T_J, T_STG$	-55 to 150	-55 to 150	°C				

Typical Thermal Resistance				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient Thermal Resistance 3)		34	°C/W	

## Note:

- 1. Pulse width<300us, Duty cycle<2%.
- 2. Fused current that based on wire numbers and diameter.
- 3. Guaranteed by design, not subject to production testing.
- 4. The maximum current rating is package limited.
- 5. Repetitive rating, pulse width limited by junction temperature  $T_{J(MAX)}$ =150°C. Ratings are based on low frequency and duty cycles to keepinitial  $T_J$  =25°C.



Electrical Characteristics (T <sub>A</sub> = 25°C UNLESS OTHERWISE NOTED)							
Characteristics	Symbol	nbol Test Condition		Limits	l lmi4		
Characteristics			Min	Тур	Max	Unit	
N-Channel Static							
Drain-Source Breakdown Voltage	B <sub>VDSS</sub>	$V_{GS}$ =0V, $I_D$ =250uA	30	-	-	V	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ , $I_{D}=250uA$	1.0	1.6	3.0	V	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10.0V, I <sub>D</sub> =15A	-	18	21	mΩ	
Diam-Source On-State Resistance		V <sub>GS</sub> =4.5V, I <sub>D</sub> =11A	-	26	36	mΩ	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ =30V, $V_{GS}$ =0V			1.0	uA	
Gate-Source Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±20V, $V_{DS}$ =0V			±100	nA	

Drain-Source Diode						
Maximum Continuous Body Diode Forward Current	I <sub>S</sub>	-	-	-	1.2	А
Diode Forward Voltage	$V_{SD}$	I <sub>S</sub> =1.0A, V <sub>GS</sub> =0V	-	-	1.5	V

Electrical Characteristics (T <sub>A</sub> = 25°C UNLESS OTHERWISE NOTED)							
Characteristics	Symbol	Symbol Test Condition -	Limits			Unit	
Cital acteristics	Symbol	rest Condition	Min	Тур	Max	Onit	
	Р	-Channel Static					
Drain-Source Breakdown Voltage	B <sub>VDSS</sub>	$V_{GS}$ =0V, $I_{D}$ =-250uA	-30	-	-	V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=-250uA$	-1	-	-2.5	V	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-12A	-	26	30	mΩ	
Dialit-Source Off-State Resistance		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-10A	-	33	44	mΩ	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ =-30V, $V_{GS}$ =0V	-	-	1.0	uA	
Gate-Source Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±20V, $V_{DS}$ =0V	-	-	±100	nA	

Drain-Source Diode						
Maximum Continuous Body Diode Forward Current	Is	-	-	-	-1.2	Α
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =-1.0A, V <sub>GS</sub> =0V	1	1	-1.5	V

## Note:

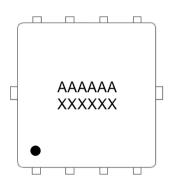
- 1. Pulse width<300us, Duty cycle<2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Repetitive rating, pulse width limited by junction temperature  $T_{J(MAX)}$ =150°C. Ratings are based on low frequency and duty cycles to keep initial  $T_J$  =25°C.
- 4. The maximum current rating is package limited.
- 5. R<sub>QJA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch2 with 2oz.square pad of copper.
- 6. Guaranteed by design, not subject to production testing.



# Package Outline Dimensions (inches and millimeters)

	DF	N333	3		h
		Dimensions			
SYMBOL	L Millimeters		Inches		
	Min	Max	Min	Max	
Α	0.70	0.80	0.03	0.03	
b	0.25	0.35	0.01	0.01	
С	0.10	0.25	0.00	0.01	
D	3.25	3.45	0.13	0.14	
D1	3.00	3.20	0.12	0.13	
D2	1.78	1.98	0.07	0.08	Land Pattern
D3	-	0.13	-	0.01	(Only for Reference)
E	3.20	3.40	0.13	0.13	
E1	3.00	3.20	0.12	0.13	
E2	2.39	2.59	0.09	0.10	E1 +0.65+ 9
е		0.65	BSC		
Н	0.30	0.50	0.01	0.02	3.55
L	0.30	0.50	0.01	0.02	1 21.29
L1	0.	13	-	0.005	
K	0.30	-	0.01	-	
θ	-	12 °	-	12 °	5270
М	-	0.15	-	0.01	0.0

# **Marking Information**



AAAAAA = Product number

XXXXXX = Tracking number

Third line = Pin1 Point

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